











Balloffet presentation



Outline of my presentation:

- Who we are
- What do we do
- Sustainability on drawing dies
- Repair on drawing dies
- Requirement for the wire industry
- New challenges









Balloffet presentation



Who I am:

- Michael Biller
- Sales manager Balloffet GmbH
- Austria and Germany
- Westerstede 40 km to North Sea
- Since 2009 on board by Balloffet









Balloffet – Who we are



153 years tradition



- A French company
- 7. generation family owned
- Manufacturer od diamond dies since 153 years
- First company in the world to develop atechnology to drill natural diamond
- First company in the world to use PCD for drawing dies
- Leading in developing and producing on machines for die repair
- Location close to Lyon
- 160 empoloyees
- Represented worldwide



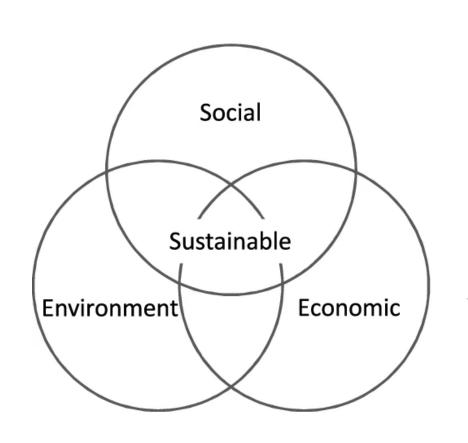


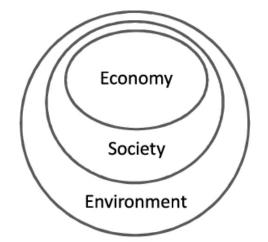


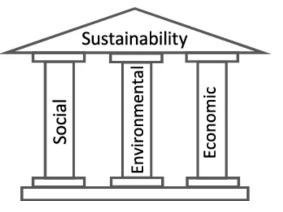


Balloffet – Sustainable









What does Wikipedia say:

Sustainability is a princip of action for the use of resources in which long-term satisfaction is to be guaranteed by preserving thee natural regeneration ability of the system

Colloquially: Long use and long benefit









Balloffet – These are our tools

















Balloffet – These are our products

















kupfer_



Sustainability in the wire business



Repair on dies









Used and worn drawing dies







Not possible to achiew a acceptable drawing result





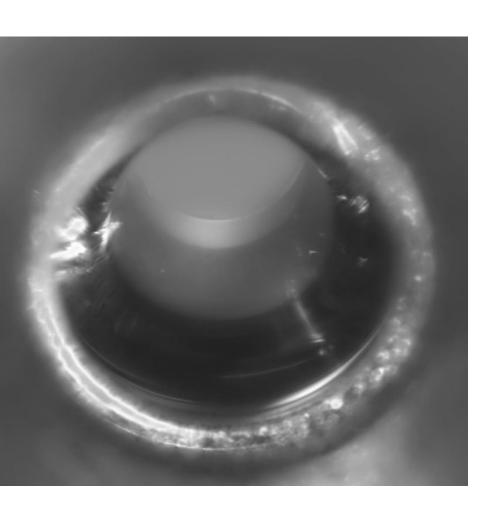




kupfer

Drawing die – Natural Diamond – New





This is what a new drawing die should look like:

According to the required geometry

- Bearing
- Drawing angle
- Back relief
- Entrance and exit
- Stamping









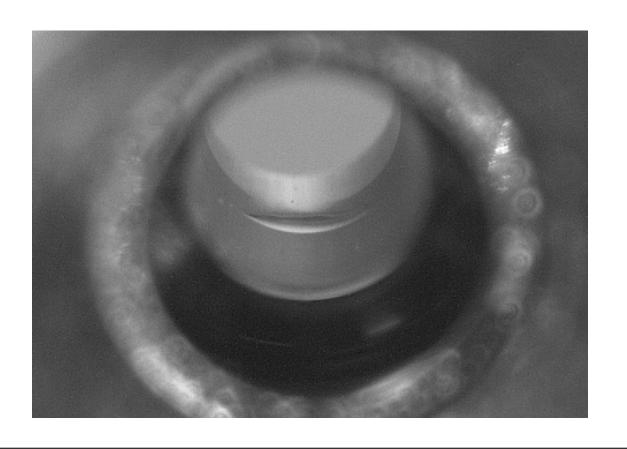


ND drawing die – medium drawing ring



Drawing die after medium use:

- Touching point from wire into the die perfectly to identify
- Medium drawing ring but deep
- Damage to se in the bearing
- Result:
- Recut on the complete geometry
- New diameter has to produced
- After this: like a brand-new die









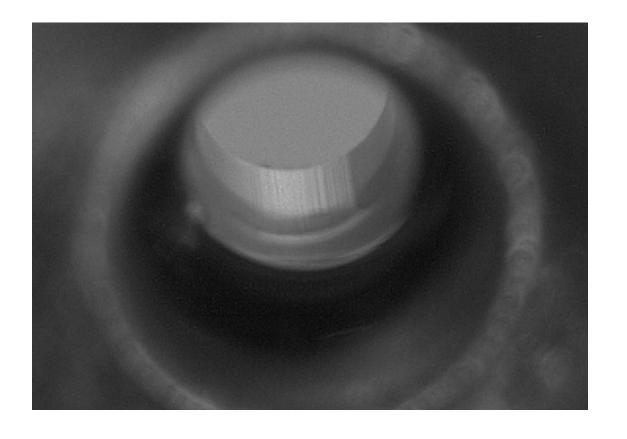


ND drawing die – big damage



Optical checking:

- Deep and very big drawing ring
- Fines from copper has damaged the bearing this is to see on the wire surface.
- Possible to rework the die
- Not on the next step in the drawing die set but eventually the next/next position











Analysing of a drawing die



Optical checking

- Mikroscope MicroCam from Balloffet
- Actual situation
- Questions share the file with your expert and contact the technical support
- Internal documentation
- Identify your situation on the drawing machine
- Ovality drawing ring
- Breackage on dies
- Not enough cooling
- > To much dust and fines





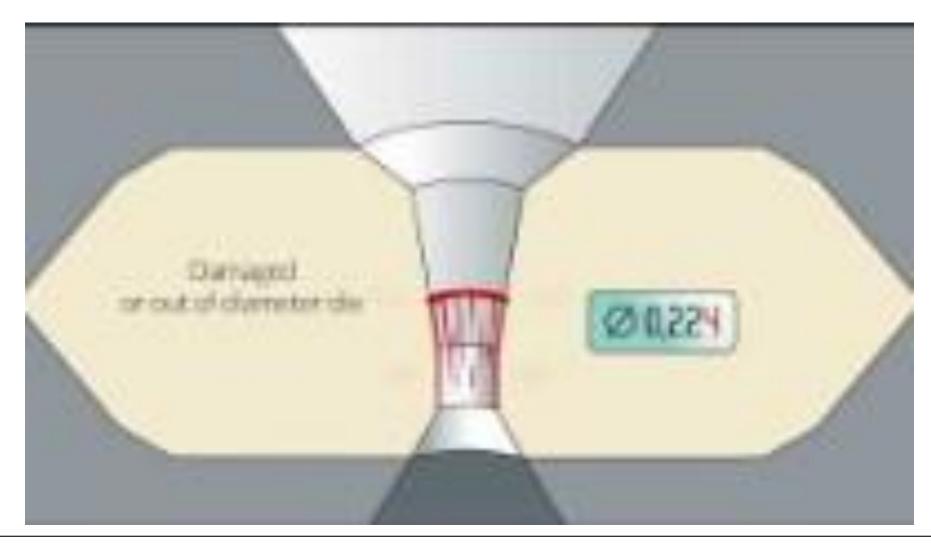






Repair of a drawing die









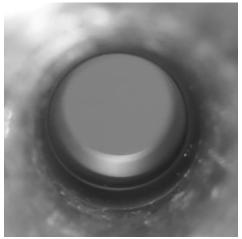


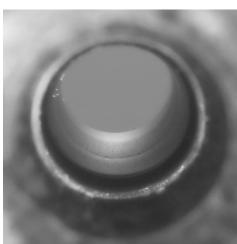


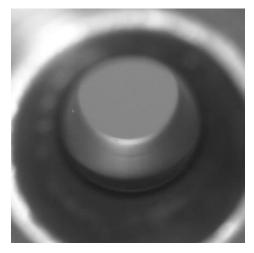
kupfer_

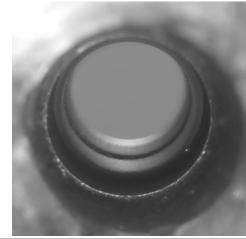
Analysing of a drawing die – PCD die

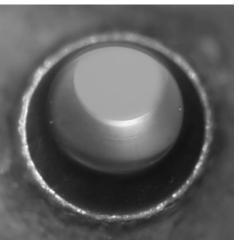


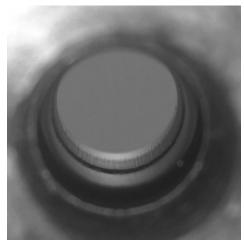




















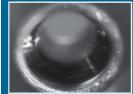


Analysing of a drawing die





Analyse von ND und PKD Ziehsteinen



Neuer Natur Diamantziehstein



eichter Ziehring



Mittlerer Ziehring



Mittlerer tiefer Ziehring Oberfläche beschädigt



Tiefer Ziehring Materialablagerung in Winkel und Ziehkanal



Diamant gebrochen



neuer PKD Ziehstein



Leichter Ziehring



Mittlerer Ziehring



PKD mit Bruch im Ziehkanal



Tiefer Ziehring Materialablagerung in Winkel und Ziehkanal



PKD gebrochen

www.balloffet.de







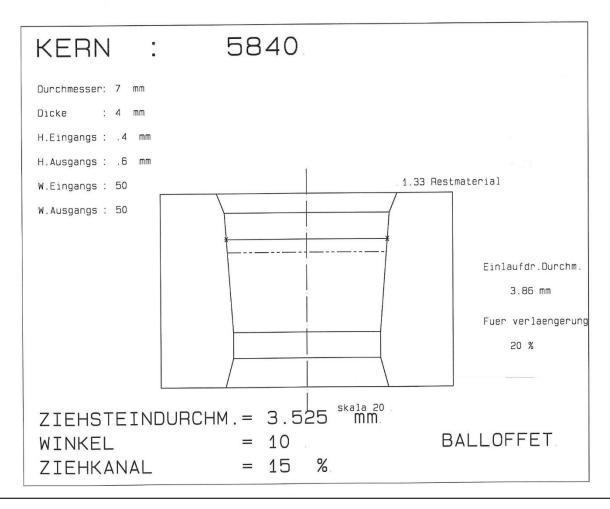






Ballofffet Ziehstein – ready for use









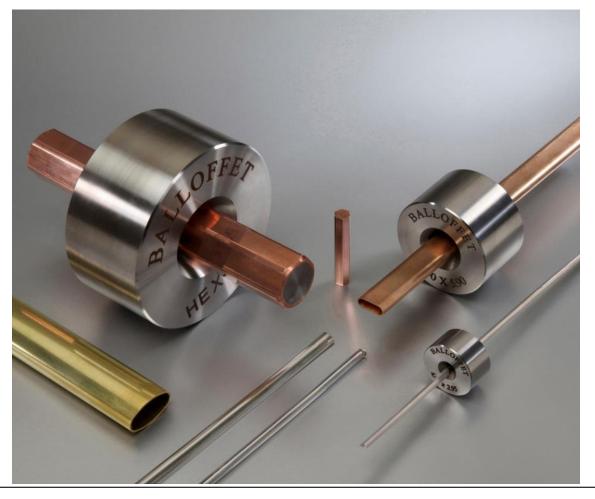




Sustainability in daily use



- Drawing dies can be used for new applications
- Special in new and coming mobility applications
- Shaped wire Non Ferrous applications
- ❖ E Mobility for cars
- ❖ E Mobility for trucks
- Energy transport
- Medicine technology
- Aeronautic
- Endless variations and possibities





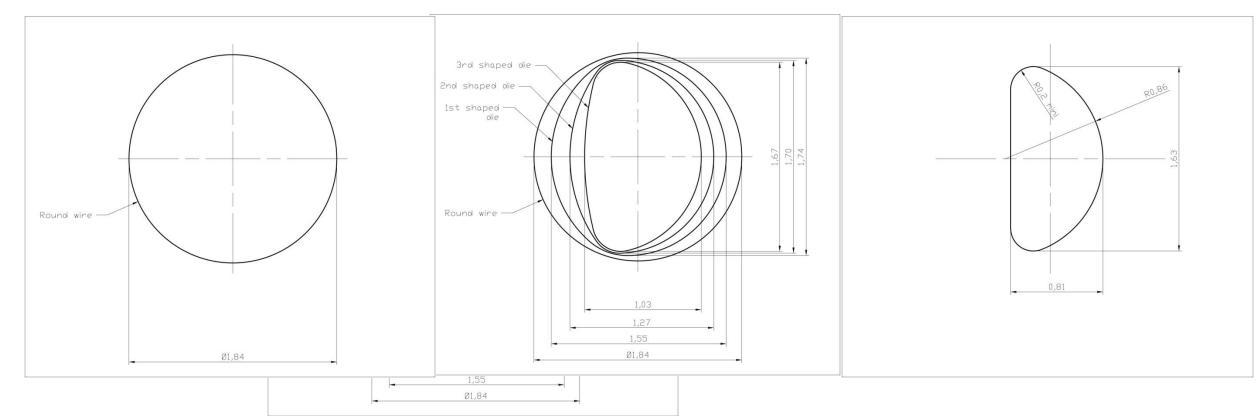






Starting from round wire to a half round wire





BALLOFFET is supporting you to install this technology from inlet wire to finished product





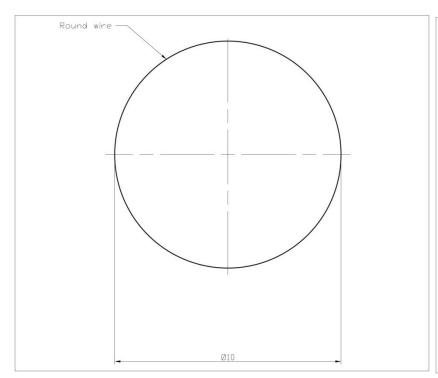


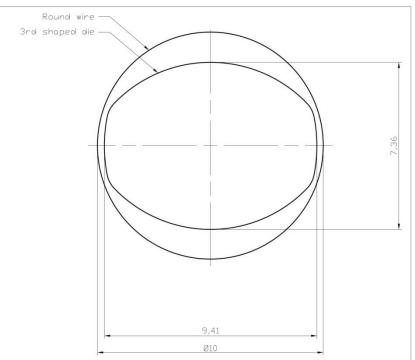


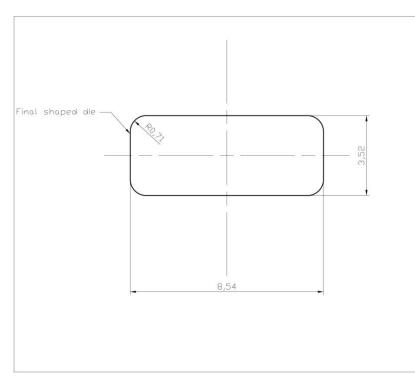


Starting from a round wire to a rectangular wire









BALLOFFET is supporting you to install this technology from inlet wire to finished product





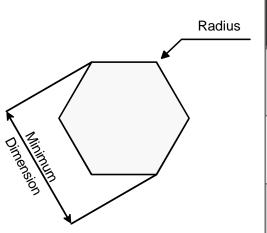






Standard sizes and tolerances





	SSCD	PCD
Minimum	0.020 mm	0.80 mm
Maximum	1.00 mm	25.00 mm
Minimum radius	< 0.01 mm	0.06 mm
Standard tolerance	2 μm bis 5 μm	5 μm bis 10 μm

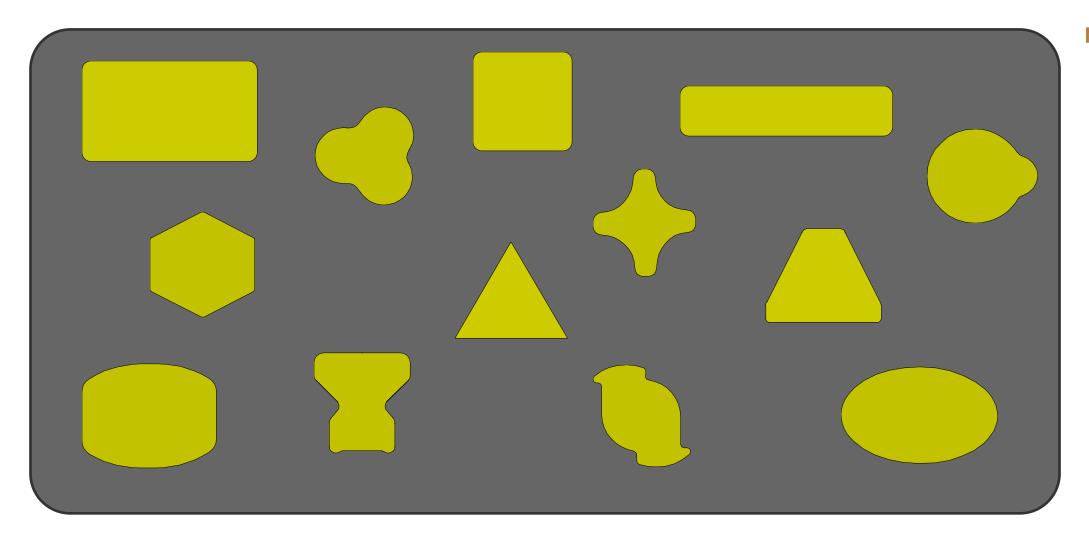
Minimum / maximum size and radius accordant to the ratio (hight and wight)

BALLÖFFET



Shaped dies / Form dies









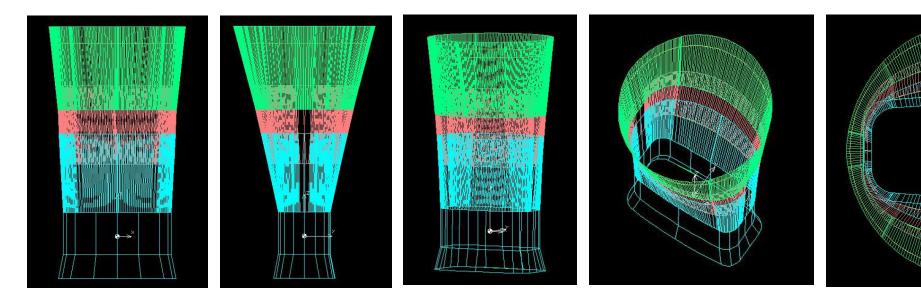


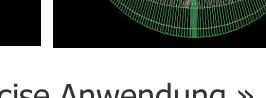




Shaped dies / Form dies







« Highly developed technology for highest and precise Anwendung »









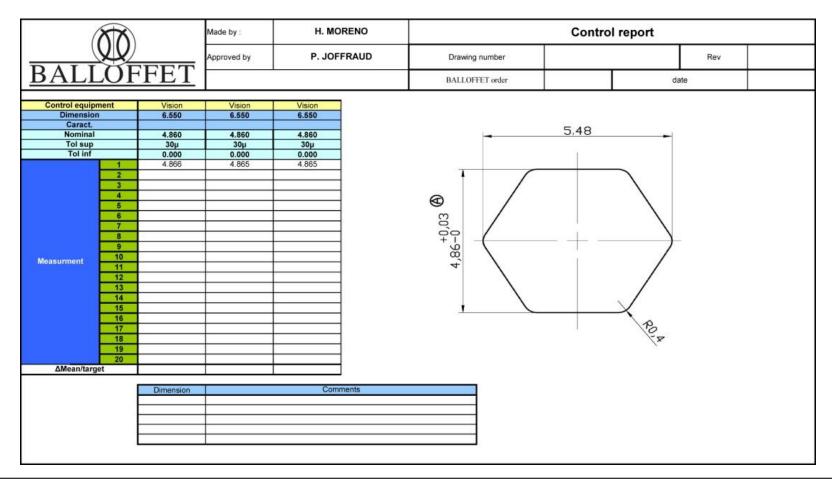
Shaped die control



Checking the internal shape / sizes /

tolerances













kupfer



www.balloffetdie.com







